

ELAD FDM-S2



USER MANUAL

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1 Overview

1.1 Sampler exploit

FDM-S2 is the second born device in our ELAD SDR SAMPLER line. This product line is developed to give the user the possibility to exploit and study the capability of Sampling technique.

With 122.88MHz sampling frequency FDM-S2 can offer the possibility to be a good HF and 6m receiver, but also allow to receive FM Band and part of VHF Band simply adding appropriate pre-selection filters in the front-end of ADC.

Some users of FDM-S2 already exploit the under-sampling technique to use it as pan adapter tuning it at IF frequencies of 68-70 MHz of their transceivers, while others use it to monitor the spectrum of a particular known frequency.

1.2 Front panel description



Power Led

Turns on when the receiver is connected to a USB port of the PC and it is switched on.

Communication Led

Shows the communication between the receiver and the PC.

1.3 Rear panel description



USB 2.0 Connector

Connection with the PC. Please use the supplied cable.

On/Off Switch

Turn On/Off the FDM-S2.

HF Antenna Input

SMA 50Ω input connector for HF band +20dBm max.

VHF Antenna Input

SMA 50Ω input connector for VHF band +20dBm max.

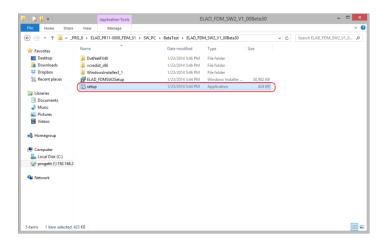
External Hardware Connector

DB9 connector for external hardware (e.g. pre-selector filters board). This is NOT a serial port.

2 Software Installation

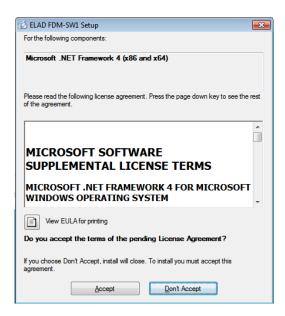
2.1 First-time install in Windows 8 and Windows 7

Double-click the file "setup.exe" in the provided USB stick.

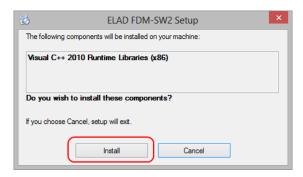


The windows installer first installs the prerequisites:

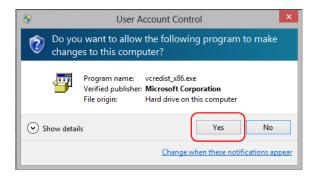
- · Microsoft VC++ 2010 Runtime libraries,
- Microsoft .NET Framework 4.0 (Only for Windows 7), and then the FDM-SW2 software.
- Click on "Accept" (Only for Windows 7)



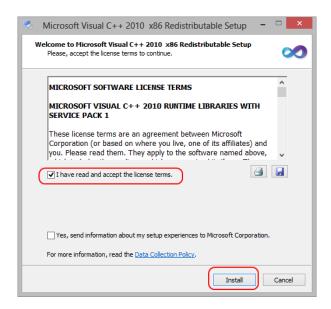
Click on "Install"



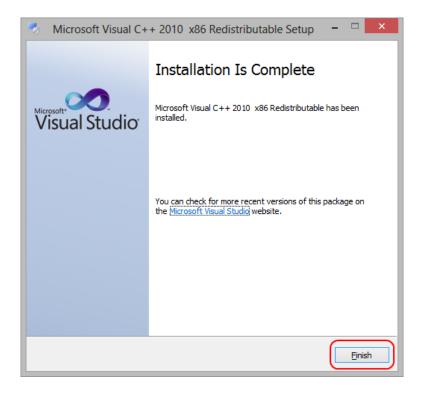
Click on "Yes"



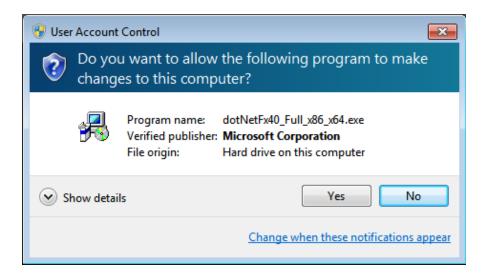
Click on "Install"



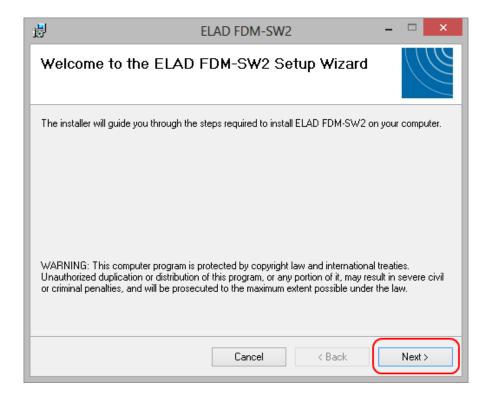
Microsoft Visual C++ 2010 x86 Redistributable installation is complete, click on "Finish"



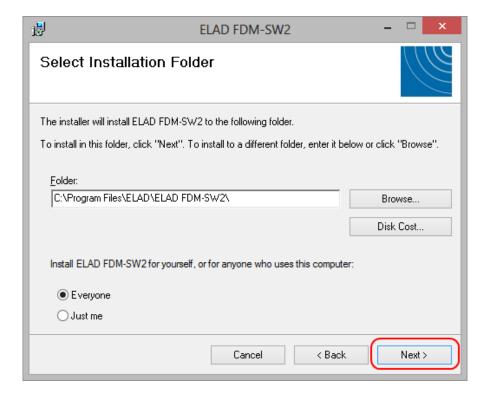
Click on "Yes" to start the installation of the .Net Framework 4.0 (Only for Windows 7)



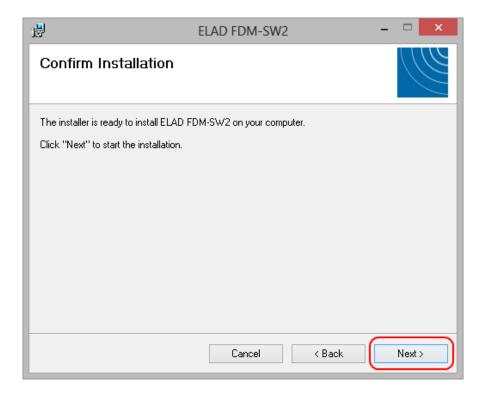
Click to "Next" to start the FDM-SW2 software installation



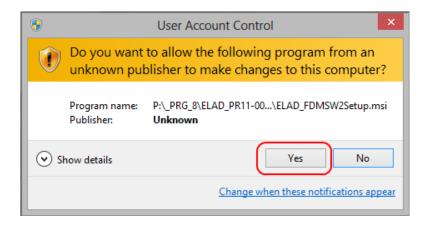
Chose the installation folder, then click on "Next"



Click on "Next"

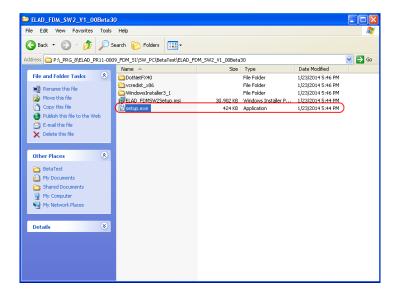


Click on "Yes"

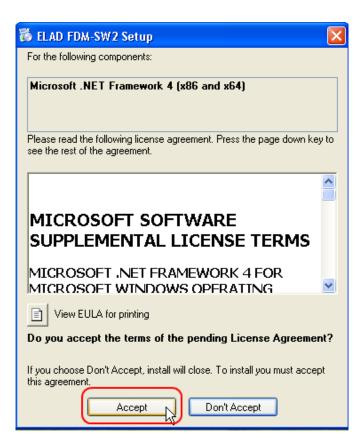


2.2 First-time install in Windows XP

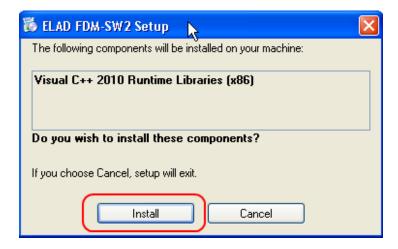
Double-click the file "setup.exe" in the provided USB stick.



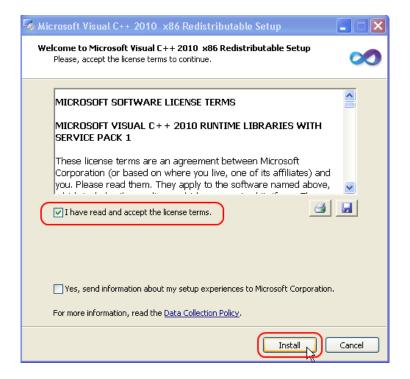
Click on "Accept"



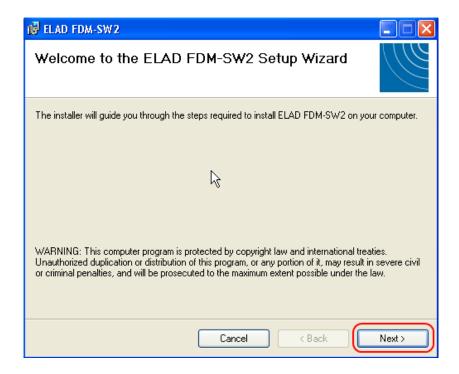
Click on "Install"



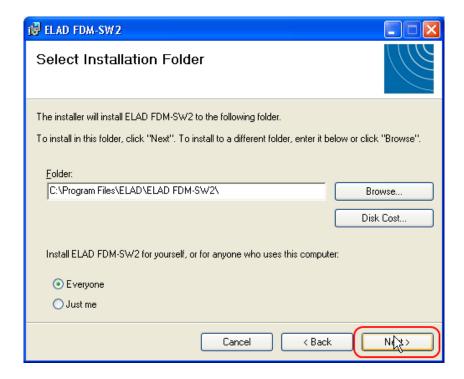
Click on "Install"



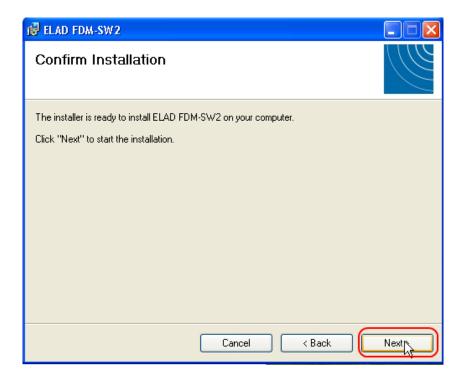
Click on "Next" to install the FDM-SW2 software



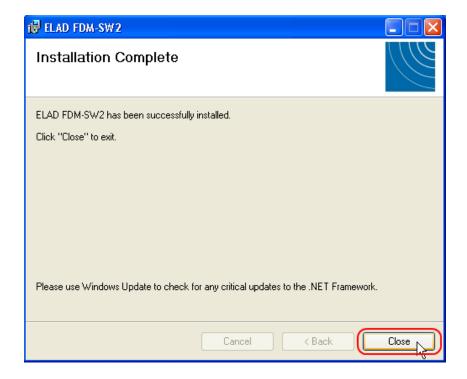
Select the installation folder, then click on "Next"



Click on "Next"



The FDM-SW2 Software installation is completed



2.3 Update an existing software version

Double click on file ELAD_FDM_SW2_V_x.xx.msi included in the update and follow the instructions.

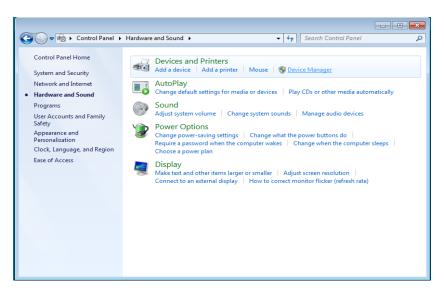
3 USB Driver Installation

3.1 Driver Installation in Windows 8 and Windows 7

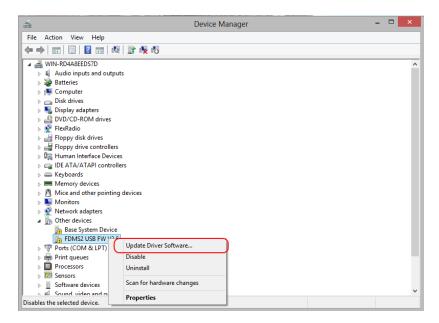
3.1.1 First driver installation

To install ELAD FDM-S2 driver, connect FDM-S2 sampler to a USB 2.0 socket on PC to power on the device. When Windows detects the new hardware, follow the steps listed below to install driver correctly:

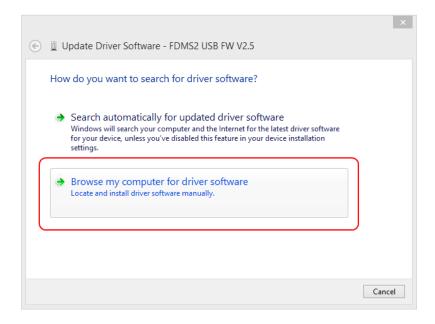
Open **Control Panel** from **Start** menu, select "System" and "Device Manager". Expand "Other Devices" node: the system reads FDM-S2 firmware version named as "FDMS2 USB FW 2.x" (or 3.x).



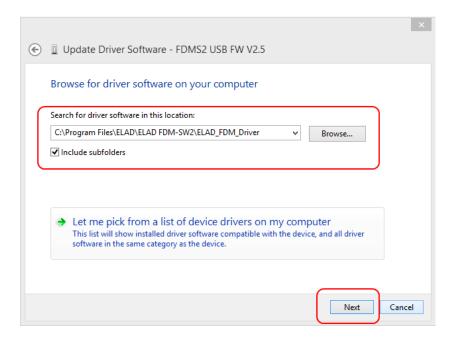
Select "FDMS2 USB FW 2.x" (or 3.x), right click on it and execute "Update driver software".



When Windows starts the installation procedure, select the option "Browse my computer for driver software" (the second option).



In the next dialog-box, insert the driver folder location using "Browse" button and check the option "Include subfolders". In this way manual driver search is enabled.

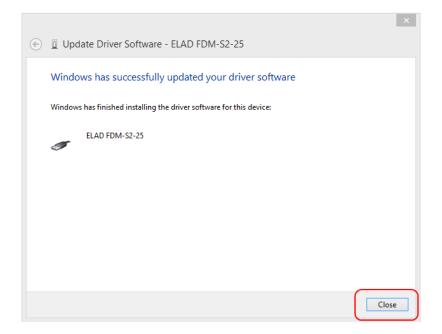


For 32 bit system select the folder: C:\Program Files\ELAD\ELAD FDM-SW2\ELAD_FDM_Driver
For 64 bit system select the folder: C:\Program Files (x86)\ ELAD\ELAD FDM-SW2\ELAD_FDM_Driver
Then click "Next".

Click "Install".



Let the hardware installation automatically completes and, at the procedure ending, click on "Close"; then disconnect and connect FDM-S2 device on the same USB socket.

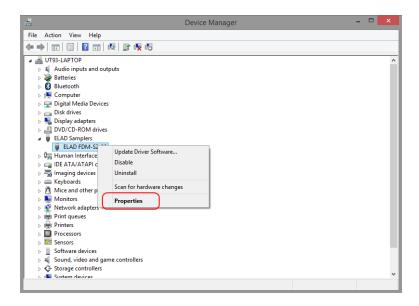


Now ELAD FDM-S2 driver is installed on your PC.

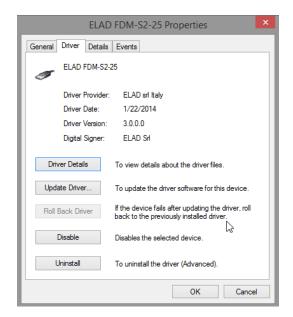
3.1.2 Driver installation verify

To verify FDM-S2 driver current version, connect the device to USB socket (where the device driver is already installed) and open **Control Panel** from **Start** menu. Click on "System" and select "Device Manager".

Expanding "ELAD Samplers" node, FDM-S2 device driver is installed as "ELAD FDM-S2-25": right click on "ELAD FDM-S2-25" and select "Properties".



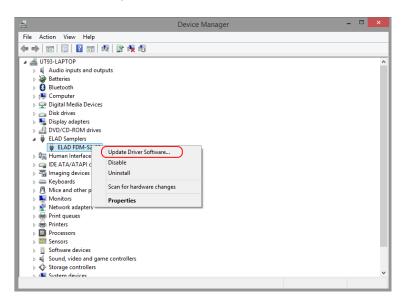
When dialog box opens, select "Driver" label: you must read provider name, current driver release date and current driver version. The figure shows an old FDM-S2 driver version.



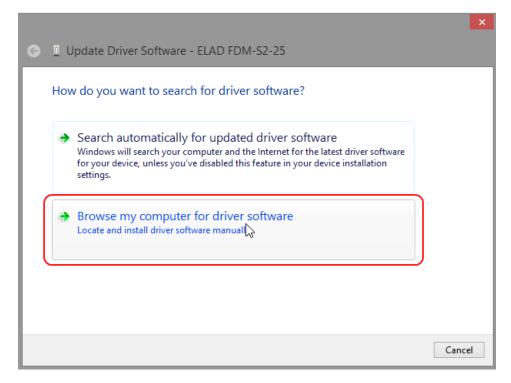
3.1.3 Manual driver update

To update FDM-S2 driver, connect the device to USB socket (where the device driver is already installed) and open **Control Panel** from **Start** menu. Click on "System" and select "Device Manager".

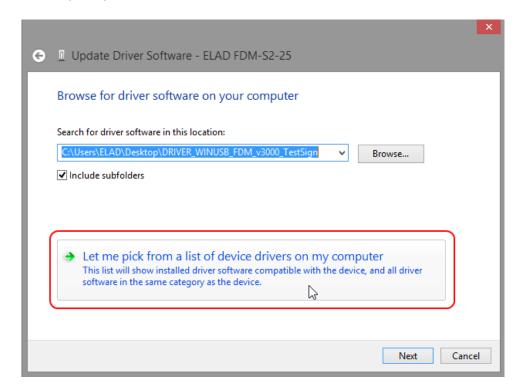
Under "ELAD samplers" list, the driver for FDM-S2 is installed as "ELAD FDM-S2-25". Select "ELAD FDM-S2-25", right click on it and execute "Update driver".



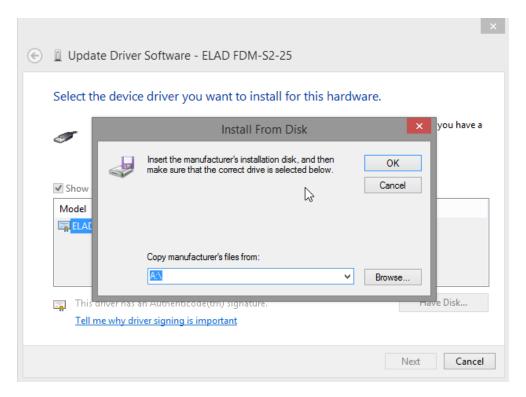
When Windows starts the installation procedure, select the last option "Browse my computer for driver software".



In the next dialog-box, disable the option "Include subfolders" and choose "Let me pick from a list of device drivers on my computer". Don't click "Next".

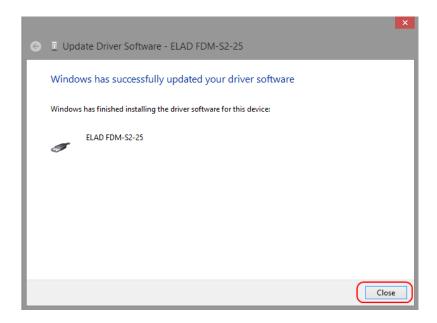


Verify that "Show compatible hardware" option is checked and ELAD FDM-S2 is selected: then click on "Have a Disk". In this way the manual driver update is enabled. Don't click "Next".

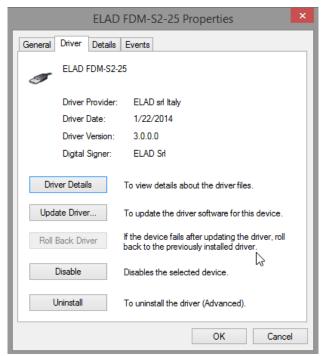


Click on "Browse" and search for FDM-S2 driver update folder location; then open winusb fdmsampler.inf file. Click "OK" and then "Next".

Let the hardware installation automatically completes and, at the procedure ending, click on "Close"; then disconnect and connect FDM-S2 device on the same USB socket.



To verify that a correct update is done, enter "Device Manager" in Control Panel; under "ELAD samplers" label select ELAD FDM-S2 driver: right click on it and choose "Properties": select "Driver" label to visualize the last driver version (an example is depicted in figure below).

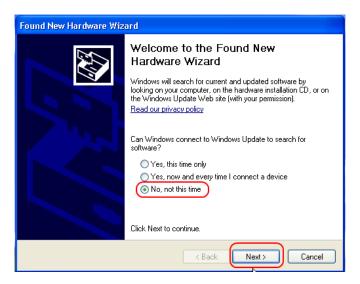


3.2 Driver Installation in Windows XP

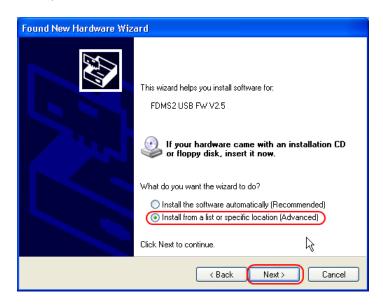
3.2.1 First driver installation

To install ELAD FDM-S2 driver, connect FDM-S2 sampler to a USB 2.0 socket on PC to power on the device. Windows XP detects the new hardware and starts the hardware installation wizard. Then, next steps to install FDM-S2 driver are listed below:

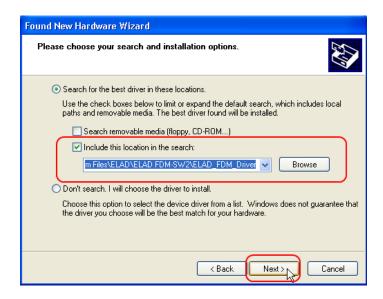
At the first dialog box, select the last option "No, not this time" and "Next".



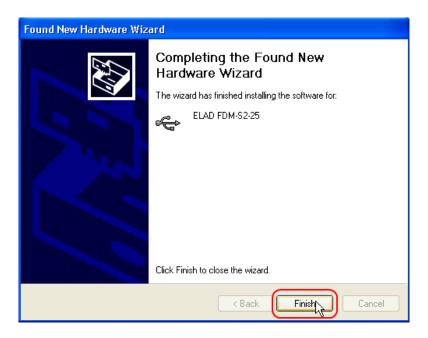
Select "Install from a list or specific location (Advanced)" and "Next".



In the next dialog-box, check the options "Search for the best driver in these location" and "Include this location in the search" to enable manual driver search. Clicking on "Browse", select the path where the driver folder is located: Local Drive (C:) \Programs\ELAD\ELAD FDM-SW2\ELAD_FDM_Driver. Then click "Next".



Let the hardware installation automatically completes and click on "Finish"; then disconnect and connect FDM-S2 device on the same USB socket.

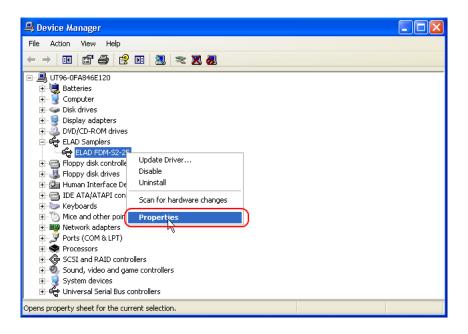


Now ELAD FDM-S2 driver is installed on your PC.

3.2.2 Driver installation verify

To verify FDM-S2 driver current version, connect the device to USB socket (where the device driver is already installed) and open **Control Panel** from **Start** menu. Click on "System" and select "Device Manager" under "Hardware" label.

Expanding "ELAD Samplers" node, FDM-S2 device driver is installed as "ELAD FDM-S2-25": right click on "ELAD FDM-S2-25" and select "Properties".



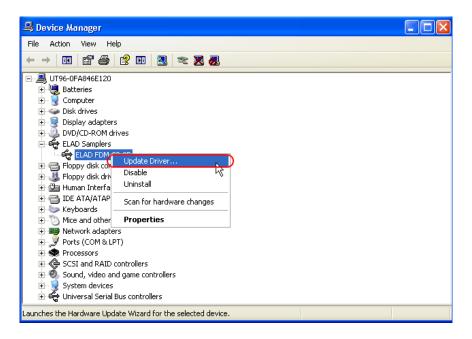
When dialog box opens, select "Driver" label: you must read provider name, current driver release date and current driver version. The old ELAD FDM-S2 driver version is shown in figure below as example.



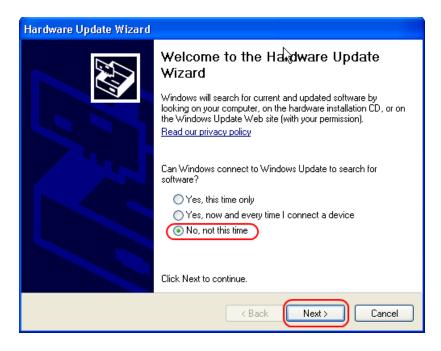
3.2.3 Manual driver update

To update FDM-S2 driver, connect the device to USB socket (where the device driver is already installed) and open **Control Panel** from **Start** menu. Click on "System" and select "Device Manager" under "Hardware" label.

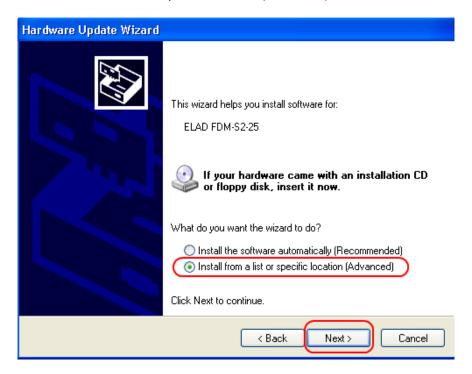
Select "ELAD FDM-S2" from "ELAD Samplers" list, right click on it and execute "Update driver"



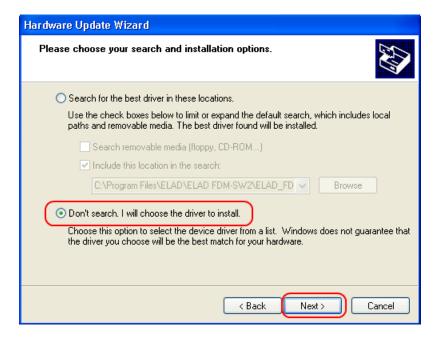
Now Windows XP launches the hardware update wizard: select the last option "No, not this time" and "Next".



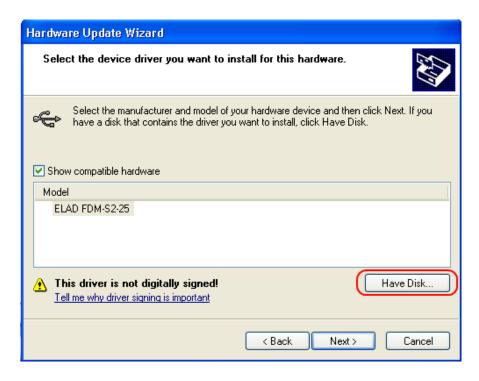
At next step select "Install from a list or specific location (Advanced)" and "Next".



Then, disable all check-boxes that the system automatically sets and choose the last option for manual driver update, as depicted in figure. Select "Next".



Verify that "Show compatible hardware" option is checked and ELAD FDM-S2 is selected: then click on "Have a Disk". Don't click "Next".

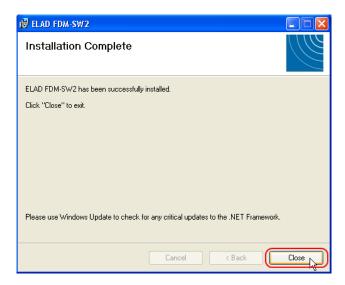


Click on "Browse" and search for the FDM-S2 driver update folder location; then open winusb fdmsampler.inf file, as depicted in figure. Click "OK" and then "Next".

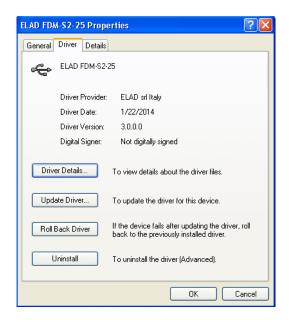


Now driver update starts: at next dialog box select "Continue Anyway" and ignore the warning.

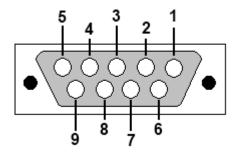
Let the hardware update automatically completes and, at the procedure ending, click on "Finish"; then disconnect and connect FDM-S2 device on the same USB socket.



To verify that a correct update is done, enter "Device Manager" from **Control Panel**; under "Universal Serial Bus controllers" list, select ELAD FDM-S2 driver, right click on it and choose "Properties". Select "Driver" label to visualize the last driver version (an example is depicted in figure below).



Annex - External Hardware Connector



- Pin 1: SFE Latch 595
- Pin 2: I2C SCL
- Pin 3: SFE CLOCK 595
- Pin 4: I2C SDA
- Pin 5: Ground
- Pin 6: Mute
- Pin 7: Reserved
- Pin 8: SFE Data 595
- Pin 9: Vcc (4.5V)

To mute the FDM-S2, connect the Pin 6 to ground.

Note: the maximum cable length should not exceed 100 mm.

Technical Specifications

Antenna Connectors Temperature Range PC Interface Power Supply Power Consumption External I/O Connector Absolute Maximum RF Input Level Dimensions 1 Weight 3 Configuration A/D Conversion Sensitivity Blocking Gain Compression Clipping Level Internal Spurious Carriers VHF1 Band RECEIVER Configuration A/D Conversion Clipping Level Internal Spurious Carriers VHF1 Band RECEIVER Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	IF+50MHz Band (10 kHz ÷ 54 MHz): Direct Sampl (HF1 Band (74-108MHz): Undersampling Mode (HF2 Band (135-148MHz): Undersampling Mode (HF2 Band (135-148MHz): Undersampling Mode (HF2 Band (135-148MHz): Undersampling Mode (HF3 & VHF1 Band input: SMA (50 Ω) SMA/BNC add (HF1 & VHF1 Bands input: SMA (50 Ω) SMA/BNC (HF1 & VHF1 Bands inp	apter included adapter included B cable required) mp/sec) typical 2.6 W			
Temperature Range PC Interface Power Supply Power Consumption External I/O Connector Absolute Maximum RF Input Level Dimensions 1 Weight Configuration A/D Conversion Sensitivity Band RECEIVER VHF1 Band RECEIVER Configuration A/D Conversion Clipping Level Internal Spurious Carriers Configuration A/D Conversion Clipping Level Internal Spurious Carriers Configuration A/D Conversion Configuration A/D Conversion Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	#HF1 & VHF1 Bands input: SMA (50 Ω) SMA/BNC 1÷ 40 °C ligh-Speed USB 2.0 (480 Mbit/s) #SB powered with double USB cable (included) #SB powered with Gouble USB (for example 192kSale #FO AM SPI interface) #SB powered With SPI interface) #SB powered With SPI interface) #FO AM SPI interface) #F	adapter included B cable required) mp/sec) typical 2.6 W rtan6 XC6LXC25 LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
PC Interface Hower Supply University Power Supply University Power Supply University Power Consumption Volume Power Configuration Volume Power Constitutive Power Compression Volume Power Compression Power Compression Volume Power Compression Volume Power Compression Power Compression Volume Power Compression Volume Power Compression Volume Power Compression Power Compression Volume Power Compression Power Com	ligh-Speed USB 2.0 (480 Mbit/s) ISB powered with double USB cable (included) ess than 4 W (5 V-750 mA) from USB (double US Vith slow Sample Rate Dlls (for example 192kSai emale DB9 (mute control, I ² C and SPI interface) 20 dBm 10 (W) x 40 (H) x 90 (D) mm 60 g Direct sampling – ADC DDC with FPGA Xilinx Span 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HHS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	rtan6 XC6LXC25 LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
FENERAL Power Supply Power Consumption External I/O Connector Absolute Maximum RF Input Level Dimensions 1 Weight 3 Configuration A/D Conversion Sensitivity Band RECEIVER Cipping Level Internal Spurious Carriers VHF1 Band RECEIVER Configuration A/D Conversion Clipping Level Internal Spurious Carriers VHF1 Band RECEIVER Configuration A/D Conversion Sensitivity Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	ISB powered with double USB cable (included) ess than 4 W (5 V-750 mA) from USB (double US Vith slow Sample Rate Dlls (for example 192kSai emale DB9 (mute control, I ² C and SPI interface) 20 dBm 10 (W) x 40 (H) x 90 (D) mm 60 g Direct sampling – ADC DDC with FPGA Xilinx Spai 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	rtan6 XC6LXC25 LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
Power Supply Power Consumption External I/O Connector Absolute Maximum RF Input Level Dimensions 1 Weight 3 Configuration A/D Conversion Sensitivity Blocking Gain Compression Clipping Level Internal Spurious Carriers VHF1 Band RECEIVER Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (CMSFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (CMSFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	ess than 4 W (5 V-750 mA) from USB (double US Vith slow Sample Rate Dlls (for example 192kSai emale DB9 (mute control, I ² C and SPI interface) 20 dBm 10 (W) x 40 (H) x 90 (D) mm 60 g Direct sampling – ADC DDC with FPGA Xilinx Spail 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz	rtan6 XC6LXC25 LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
External I/O Connector Absolute Maximum RF Input Level Dimensions 1 Weight 3 Configuration A/D Conversion Sensitivity Band RECEIVER Cipping Level Internal Spurious Carriers Configuration A/D Conversion Clipping Level Internal Spurious Carriers INOISE Floor (MDS)	Vith slow Sample Rate Dlls (for example 192kSai emale DB9 (mute control, I ² C and SPI interface) 20 dBm 10 (W) x 40 (H) x 90 (D) mm 60 g Direct sampling – ADC DDC with FPGA Xilinx Spail 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz	rtan6 XC6LXC25 LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
Absolute Maximum RF Input Level Dimensions 1 Weight 3 Configuration A/D Conversion Sensitivity Blocking Gain Compression Compression Clipping Level Internal Spurious Carriers VHF1 Band RECEIVER Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity Sensitivity Configuration A/D Conversion Sensitivity Sens	20 dBm 10 (W) x 40 (H) x 90 (D) mm 60 g Direct sampling – ADC DDC with FPGA Xilinx Span 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HHS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
RF Input Level Dimensions 1 Weight 3 Configuration A/D Conversion Sensitivity Blocking Gain Compression Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD) Compression Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	10 (W) x 40 (H) x 90 (D) mm 60 g Direct sampling – ADC DDC with FPGA Xilinx Span 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
Weight Configuration A/D Conversion Sensitivity 3rd Oder Intercept Point Band RECEIVER Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FIPPING LEVEL Internal Spurious Carriers)	Direct sampling – ADC DDC with FPGA Xilinx Span 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: .122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
Configuration A/D Conversion Sensitivity 3 rd Oder Intercept Point Blocking Gain Compression Compression Compression Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity Configuration Configuration A/D Conversion Sensitivity Configuration A/D Conversion Configuration A/D Conversion Sensitivity Configuration A/D Conversion	Direct sampling – ADC DDC with FPGA Xilinx Span 122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
A/D Conversion Sensitivity 3rd Oder Intercept Point Blocking Gain Compression Compression Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (CONFIGURATION OF THE POINT OF T	122.88 MSPS @ 16 bit/sample HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	LS ⁽²⁾ Typical: -110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
Sensitivity 3rd Oder Intercept Point Blocking Gain Compression Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (CONFIGURATION OF CONFIGURATION OF CON	HS ⁽¹⁾ Typical: -122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	-110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
Sensitivity 3rd Oder Intercept Point Blocking Gain Compression Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	-122 dBm (CW, BW 500 Hz, 10 dB (S+N)/N) HS ⁽¹⁾ Typical: +23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	-110 dBm (CW, BW 500 Hz, 10 dB (S+N)/N)			
ACCEIVER ACCEIVER Blocking Gain Compression Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FIPM @ 12 dB SINAD)	+23 dBm @ 14 MHz, Spacing 2 kHz +16 dBm @ 50 MHz, Spacing 2 kHz Typical: > 115 dB @ 10 MHz, Spacing 2 kHz, CW,	LS ⁽²⁾ Typical:			
Band RECEIVER Blocking Gain Compression Noise Floor (MDS)		+31 dBm @ 14 MHz, Spacing 2 kHz +25 dBm @ 50 MHz, Spacing 2 kHz			
VHF1 Band RECEIVER Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD)	(2)	BW 500 Hz			
Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	HS ⁽¹⁾ Typical: -132 dBm @ 14 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off -138 dBm @ 14 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off -130 dBm @ 50 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off -136 dBm @ 50 MHz, CW, BW 500 Hz, NR ⁽³⁾ On	LS ⁽²⁾ Typical: -120 dBm @ 14 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off -126 dBm @ 14 MHz, CW, BW 500 Hz, NR ⁽³⁾ On -118 dBm @ 50 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off -124 dBm @ 50 MHz, CW, BW 500 Hz, NR ⁽³⁾ On			
VHF1 Band RECEIVER Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	HS ⁽¹⁾ : -8 dBm @ 14 MHz, -12 dBm @ 50 MHz	LS ⁽²⁾ : +4 dBm @ 14 MHz, 0 dBm @ 50 MHz			
Configuration A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) 3 rd Oder Intercept Point Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	Typical: < -115 dBm @ 384 kSamp/sec, HS ⁽¹⁾				
A/D Conversion Sensitivity (WBFM @ 12 dB SINAD) 3 rd Oder Intercept Point Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)					
Sensitivity (WBFM @ 12 dB SINAD) 3rd Oder Intercept Point Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	Jndersampling – ADC DDC with FPGA Xilinx Spar 122.88 MSPS @ 16 bit/sample	talib ACBLAC25			
(WBFM @ 12 dB SINAD) 3rd Oder Intercept Point Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)					
Band RECEIVER Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	HS ⁽¹⁾ Typical: 2.5 μV @ 98 MHz	LS ⁽²⁾ Typical: 10 μV @ 98 MHz			
Noise Floor (MDS) Clipping Level Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	HS ⁽¹⁾ Typical: +21 dBm @ 98 MHz, Spacing 2 kHz	LS ⁽²⁾ Typical: +29 dBm @ 98 MHz, Spacing 2 kHz			
Internal Spurious Carriers Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	HS ⁽¹⁾ Typical: .126 dBm @ 98 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off .132 dBm @ 98 MHz, CW, BW 500 Hz, NR ⁽³⁾ On	LS ⁽²⁾ Typical: -114 dBm @ 98 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off -120 dBm @ 98 MHz, CW, BW 500 Hz, NR ⁽³⁾ On			
Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	HS ⁽¹⁾ : -3 dBm @ 98 MHz	LS ⁽²⁾ : +9 dBm @ 98 MHz			
Configuration A/D Conversion Sensitivity (FM @ 12 dB SINAD)	Typical: < -110 dBm @ 384 kSamp/sec, HS ⁽¹⁾				
A/D Conversion Sensitivity (FM @ 12 dB SINAD)					
Sensitivity (FM @ 12 dB SINAD)	122.88 MSPS @ 16 bit/sample				
	Typical: 0.4 μV @ 145 MHz, NR ⁽³⁾ Off 0.2 μV @ 145 MHz, NR ⁽³⁾ On				
3 ^{ra} Oder Intercept Point	Typical: +5 dBm @ 145 MHz, Spacing 2 kHz				
Noise Floor (MDS)	Typical: -137 dBm @ 145 MHz, CW, BW 500 Hz, NR ⁽³⁾ Off -143 dBm @ 145 MHz, CW, BW 500 Hz, NR ⁽³⁾ On				
i de la companya de	Typical: -19 dBm @ 145 MHz				
Internal Spurious Carriers	Typical: < -100 dBm @ 384 kSamp/sec				
FM Band Rejection	> 60 dB Typical: 75 dB Measured: 80dB @ 145 MHz, Interferer @ 100.76 MHz ty Mode, ⁽³⁾ Noise Reduction				

Declaration of Conformity (EC)

The product marked as

FDM-S2

manufactured by

Manufacturer: ELAD S.r.l.

Address: Via Col De Rust, 11 - Sarone

33070 CANEVA (PN)

is produced in conformity to the requirements contained in the following EC directives:

- ➤ R&TTE Directive 1999/5/CE
- ➤ EMC Directive 2004/108/CE
- ➤ Low Voltage Directive 2006/95/CE
- RoHS Directive 2011/65/CE

The product conforms to the following Product Specifications:

Emissions & Immunity:

ETSI EN 300 330-1 ETSI EN 301 489-1

ETSI EN 301 489-15

ETSI EN 301 783-2

EN 55022: 2006 + A1: 2007

EN 55024: 1998 + A1: 2001 + A2: 2003

Safety:

EN 60950-1: 2006 + A11: 2009

And further amendments.

This declaration is under responsibility of the manufacturer:

ELAD S.r.l.

Via Col De Rust, 11 - Sarone 33070 CANEVA (PN)

Issued by:

Name: Franco Milan President of ELAD Function:

> January, 29th 2014 Caneva Place Date

Declaration of Conformity (FCC)

The product marked as

FDM-S2

manufactured by

Manufacturer: ELAD S.r.l.

Address: Via Col De Rust, 11 - Sarone

33070 CANEVA (PN)

complies with the following requirements:

- FCC (Federal Communications Commission) Part 15

Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Changes or modification not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC ID: 2AAE5FDM-S2

This product is distributed in USA by:

ELAD USA Inc. 7074 N RIDGE BLVD APT 3E CHICAGO , IL 606453586 USA

Pho: 312-320-8160